



Pin Assignments

ULN2002A/ ULN2003A/ ULN2004A

HIGH VOLTAGE, HIGH CURRENT DARLINGTON TRANSISTOR ARRAYS

Description

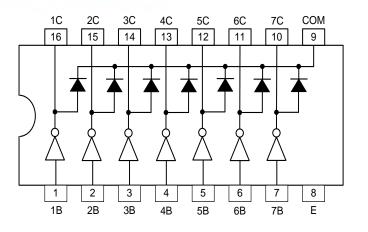
The ULN2002A, ULN2003A and ULN2004A are high voltage, high		
current Darlington arrays each containing seven open collector	(Top View)	
common emitter pairs. Each pair is rated at 500mA. Suppression		
diodes are included for inductive load driving, the inputs and outputs	1B 1 0 16	5] 1C
are pinned in opposition to simplify board layout.	2B 2	5] 2C
Device options are designed to be compatible with common logic	3B 3	4 3C
families:	4B 4	3] 4C
ULN2002A (14-25V PMOS)		2] 5C
ULN2003A (5V TTL, CMOS)		1] 6C
ULN2004A (6-15V CMOS, PMOS)		
] 7C
These devices are capable of driving a wide range of loads including	E 8 9	COM
solenoids, relays, DC motors, LED displays, filament lamps, thermal		
print-heads and high-power buffers.	SO-16	
The ULN2002A, ULN2003A and ULN2004A are available in both a		
small outline 16-pin package (SO-16) and PDIP-16 package.	(Top View)	
	(10)	
Features	1B 1	5]1C
500mA Rated Collector Current (Single Output)	2B 2	5 2C
High Voltage Outputs: 50V	3B 3	4 3C
Output Clamp Diodes	4B 4	3 4C
Inputs Compatible with Popular Logic Types	5B 5	2] 5C
Relay Driver Applications		1] 6C
"Green" Molding Compound (No Br, Sb)		
Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)		D 7C
Halogen and Antimony Free. "Green" Device (Note 3)	E 8 9	COM
	PDIP-16	

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.

Connection Diagram



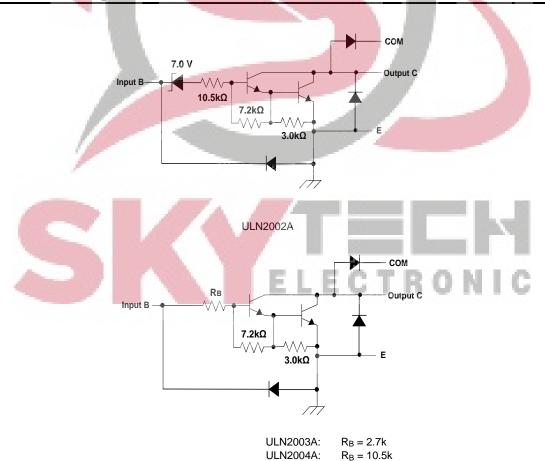




Pin Descriptions

Pin Number SO-16/PDIP-16	Pin Name	Function		
1	1B	Input Pair 1		
2	2B	Input Pair 2		
3	3B	Input Pair 3		
4	4B	Input Pair 4		
5	5B	Input Pair 5		
6	6B	Input Pair 6		
7	7B	Input Pair 7		
8	E	Common Emitter (Ground)		
9	COM	Common Clamp Diodes		
10	70	Output Pair 7		
11	6C	Output Pair 6		
12	5C	Output Pair 5		
13	4C	Output Pair 4		
14	3C	Output Pair 3		
15	2C	Output Pair 2		
16	1C	Output Pair 1		

Functional Block Diagram



ULN2003A, ULN2004A



Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter		Rating	Unit
V _{CC}	Collector to Emitter Voltage		50	V
VR	Clamp Diode Reverse Voltage (Note 5)		50	V
VI	Input Voltage (Note 5)		30	V
I _{CP}	Peak Collector Current		500	mA
I _{OK}	Output Clamp Current	500		
I _{TE}	Total Emitter Current	-2.5	А	
0	Thermal Resistance Junction-to-Ambient (Note 6)	SO-16	63.0	°C/W
θ _{JA}		PDIP-16	50.0	
0	Thermal Registeres Junction to Case (Note 7)	SO-16	12.0	°C/W
θ_{JC}	Thermal Resistance Junction-to-Case (Note 7) PDIP-16		15.0	C/VV
TJ	Junction Temperature		+150	°C
T _{STG}	Storage Temperature	100 M	-65 to +150	°C

Notes: 4. Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

5. All voltage values are with respect to the emitter/substrate terminal E, unless otherwise noted.

6. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of +150°C can affect reliability.

7. Maximum power dissipation is a function of $T_J(max)$, θ_{JC} and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_C)/\theta_{JC}$. Operating at the absolute maximum T_J of +150°C can affect reliability.

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V _{CC}	Collector to Emitter Voltage		50	V
T _A	Operating Ambient Temperature	-40	+105	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

ULN2002A								
Symbol	Parameter	Test Figure	Test C	onditions	Min	Тур	Max	Unit
V _{I(ON)}	On State Input Voltage	6	$V_{CE} = 2V$, $I_C = 30$	00mA			13	V
			l <mark>ı = 250</mark> µA, l _C = 1	00mA	-	0.9	1.1	
V _{CE(SAT)}	Collector Emitter Saturation Voltage	5	$I_{I} = 350 \mu A, I_{C} = 2$	200mA		1	1.3	V
	Voltago		$I_{I} = 500 \mu A$, $I_{C} = 3$	50mA		1.2	1.6	
VF	Clamp Forward Voltage	8	I _F = 350mA	ECTI	6.7	1.7	2	V
		1	$V_{CE} = 50V, I_I = 0$				50	
I _{CEX}	Collector Cut-off Current		$V_{CE} = 50V,$	$I_{I} = 0$	—		100	μA
		2	T _A = +105°C	$V_I = 6V$	—		500	
I _{I(OFF)}	Off State Input Current	3	$V_{CE} = 50V, I_C = 50V$	500µA	50	65	_	μA
h	Input Current	4	V _I = 17V		—	0.82	1.25	mA
1-	Clamp Reverse Current	-		T _A = +105°C	_		100	
I _R	Clamp Reverse Current	1	7 $V_R = 50V$	—	—	—	50	μA
Ci	Input Capacitance	_	$V_{I} = 0, f = 1MHz$		_	_	25	pF



Electrical Characteristics (Cont.) (@T_A = +25°C, unless otherwise specified.)

JLN2003/	Parameter	Test Figure	Tost C	onditions	Min	Тур	Max	Uni
	Falameter	Test Figure	Test G	$I_{\rm C} = 200 \text{mA}$	WIIII	тур	2.4	0111
Maria	On State Input Voltage	6	V _{CE} = 2V	$I_C = 250 \text{mA}$ $I_C = 250 \text{mA}$			2.4	V
V _{I(ON)}	On State input voltage	0	V CE = 2 V	$I_C = 250 \text{mA}$ $I_C = 300 \text{mA}$			3	v
			$I_1 = 250 \mu A, I_C = 2$	-		0.9	1.1	
	Collector Emitter Saturation	5	$I_1 = 250\mu A, I_C = 1$ $I_1 = 350\mu A, I_C = 2$			0.9	1.1	V
V _{CE(SAT)}	Voltage	5	-			1.2	1.5	v
\/_	Clamp Forward Voltage	8	$I_1 = 500 \mu A$, $I_C = 3$	Amuca		1.2	2	V
VF		0	$I_F = 350 \text{mA}$				_	V
I _{CEX}	Collector Cut-off Current	2	$V_{CE} = 50V, I_I = 0$ $V_{CE} = 50V,$	$I_1 = 0$	1	_	50 100	μA
		1	T _A = +105°C					
I _{I(OFF)}	Off State Input Current	3	$V_{CE} = 50V, I_C = 50V$	500µA	50	65	_	μA
lı	Input Current	4	$V_{I} = 3.85V$		4	0.93	1.35	mA
I _R	Clamp Reverse Current	7	V _R = 50V	T _A = +105°C	Æ-	_	100 50	μA
CI	Input Capacitance	- / - /	$V_1 = 0$, f = 1MHz		_	15	25	pF
JLN2004/	A							
	Parameter	Test Figure	Test Co	onditions	Min	Тур	Max	Uni
				$I_C = 125 mA$		-	5	
Veren	On State Input Voltage	6	V _{CE} = 2V	I _C = 200mA	—	-	6	v
VI(ON)		0	V CE = 2 V	$I_{\rm C} = 275 {\rm mA}$	—	-	7	v
				I _C = 350mA	—	-	8	
			l _I = 250μA, I _C = 10	00mA	- N	0.9	1.1	
V _{CE(SAT)}	Collector Emitter Saturation Voltage	5	$I_I = 350 \mu A, I_C = 20$	00mA	_	1	1.3	V
	Vonage		lı = 500µA, lc = 35	i0mA	_	1.2	1.6	
VF	Clamp Forward Voltage	8	I _F = 350mA		_	1.7	2	V
		1	$V_{CE} = 50V, I_I = 0$		_		50	
ICEX	Collector Cut-off Current			I = 0			100	μA
	-	2	$V_{CE} = 50V, T_A = +$	$105^{\circ}C$ V _I = 6V	_		500	
I _{I(OFF)}	Off State Input Current	3	$V_{CE} = 50V, I_C = 50V$		50	65	_	μA
h li	Input Current	4	$V_{I} = 5V$			0.35	0.5	m/
				T _A = +105°C	_		100	
	Clamp Reverse Current	7	$V_R = 50V$			- 7	50	μA
I _R								



Electrical Characteristics (Cont.) (@T_A = -40°C to +105°C, unless otherwise specified.)

ULN2003/	ILN2003A								
	Parameter	Test Figure	Test Figure Test Conditions		Min	Тур	Max	Unit	
				$I_{\rm C} = 200 {\rm mA}$	—	—	2.7		
V _{I(ON)}	On State Input Voltage	6	$V_{CE} = 2V$	I _C = 250mA	—	_	2.9	V	
				$I_{\rm C} = 300 {\rm mA}$	—	_	3		
			I _I = 250µA, I _C = 100mA		—	0.9	1.2		
VCE(SAT)	Collector Emitter Saturation Voltage	5	I _I = 350µA, I _C = 200mA		—	1	1.4	V	
			$I_1 = 500 \mu A, I_C = 350 m A$		—	1.2	1.7		
VF	Clamp Forward Voltage	8	I _F = 350mA	I _F = 350mA		1.7	2.2	V	
ICEX	Collector Cut-off Current	1	V _{CE} = 50V, I _I =	$V_{CE} = 50V, I_I = 0$			100	μA	
I _{I(OFF)}	Off State Input Current	3	$V_{CE} = 50V, I_C =$	= 500µA	30	65	_	μA	
li –	Input Current	4	VI = 3.85V	V ₁ = 3.85V		0.93	1.35	mA	
I _R	Clamp Reverse Current	7	$V_R = 50V$	V _R = 50V			100	μA	
CI	Input Capacitance		$V_{I} = 0, f = 1MH$	z	-	15	25	pF	

Switching Characteristics (@T_A = +25°C, unless otherwise specified.)

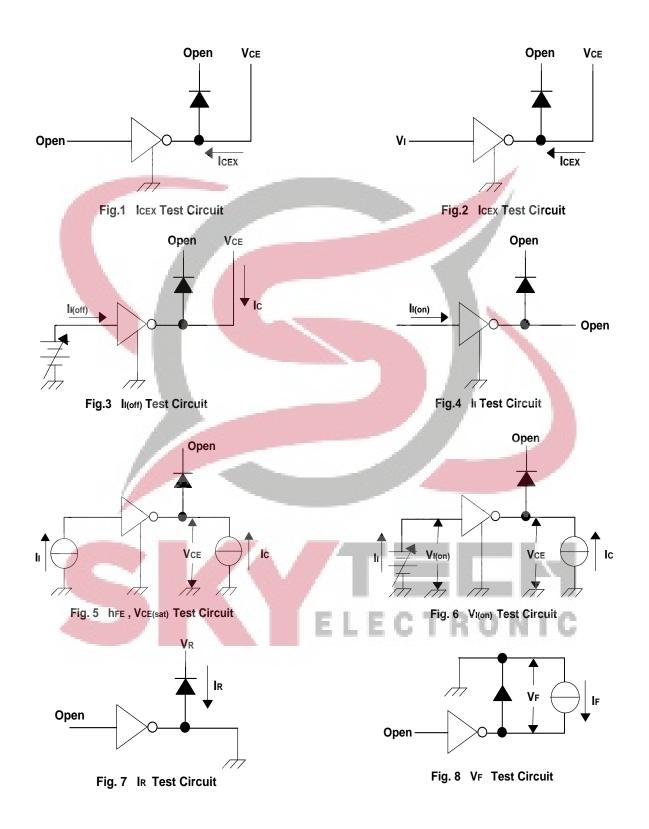
ULN2002A, ULN2003A, ULN2004A									
	Parameter	Test figure	Min	Тур	Max	Unit			
t _{PLH}	Propagation Delay Time, Low to High Level Output	9	-	0.25	1	μs			
tPHL	Propagation Delay Time, High to Low Level Output	9	-	0.25	1	μs			
Vон	High Level Output Voltage after Switching	9 (V _S = 50V, I _O = 300mA)	V _S -20		—	mV			

Switching Characteristics (@T_A = -40 to +105°C, unless otherwise specified.)

JLN2003	A			1		
	Parameter	Test figure	Min	Тур	Max	Unit
t _{PLH}	Propagation Delay Time, Low to High Level Output	9	—	1	10	μs
t _{PHL}	Propagation Delay Time, High to Low Level Output	9	—	1	10	μs
V _{OH}	High Level Output Voltage after Switching	9 (V _S = 50V, I _O = 300mA)	V _S -50		-	mV
	SKY	ELECTR	0			

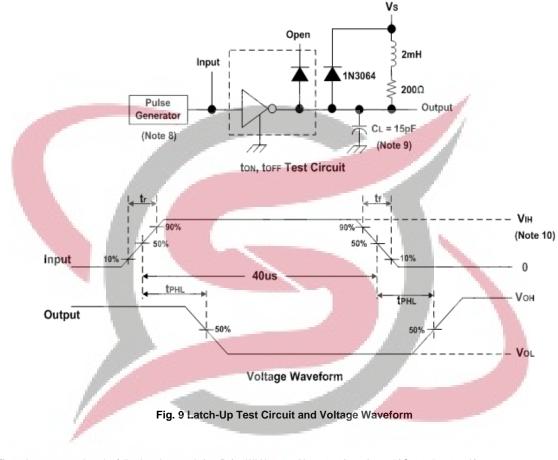


Parameter Measurement Circuits





Parameter Measurement Circuits (Cont.)



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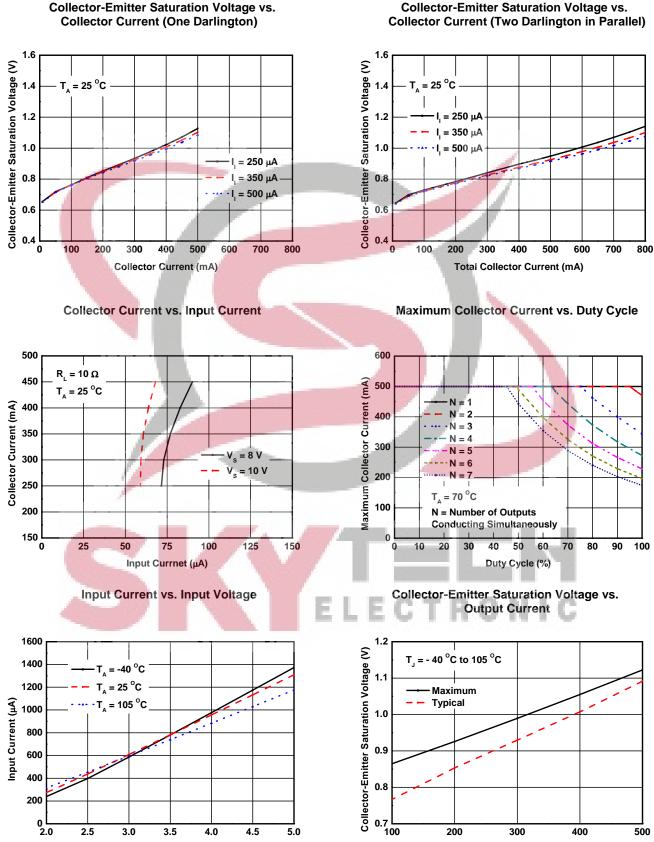
 Notes:
 8. The pulse generator has the following characteristics: Pulse Width = 12.5Hz, output impedance 50Ω, tr ≤ 5ns, tr ≤ 10ns.

 9. CL includes prove and jig capacitance.
 10. For testing the ULN2002A, V_{IH} = 13V; for the ULN2003A, V_{IH} = 3V; for the ULN2004A, V_{IH} = 8V.





Typical Performance Characteristics



13

of

Input Voltage (V)

ULN2002A/ ULN2003A/ ULN2004A

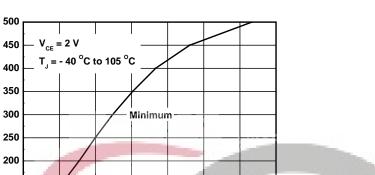
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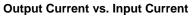
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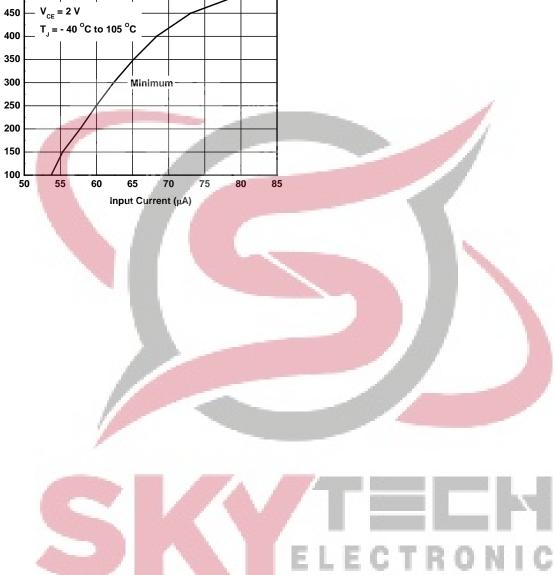


Output Current (mA)

Typical Performance Characteristics (Cont.)







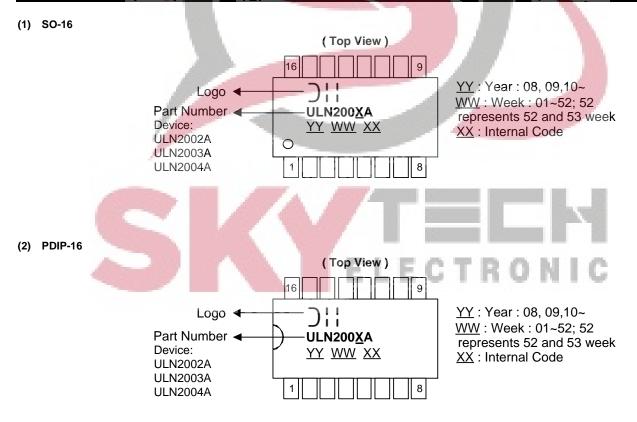


Ordering Information

Device	Package	Packing						
ULN2002A : 14~25V ULN2003A : 5V TTL ULN2004A : 6~15V	S16 : SO-16 D16 : PDIP-16	13 : Tape & Reel U : Tube						

	Baakaga		13" Tape and	d Reel	Т	ube
Part Number	Part Number Package Code		Quantity	Part Number Suffix	Quantity	Part Number Suffix
ULN2002AS16-13	S16	SO-16	2,500/Tape & Reel	-13	NA	NA
ULN2003AS16-13	S16	SO-16	2,500/Tape & Reel	-13	NA	NA
ULN2004A <mark>S16-1</mark> 3	S16	SO-16	2,500/Tape & Reel	-13	NA	NA
ULN2002AD16-U	D16	PDIP-16	NA	NA	25/Tube	-U
ULN2003AD16-U	D16	PDIP-16	NA	NA	25/Tube	-U
ULN2004AD16-U	D16	PDIP-16	NA	NA	25/Tube	-U

Marking Information



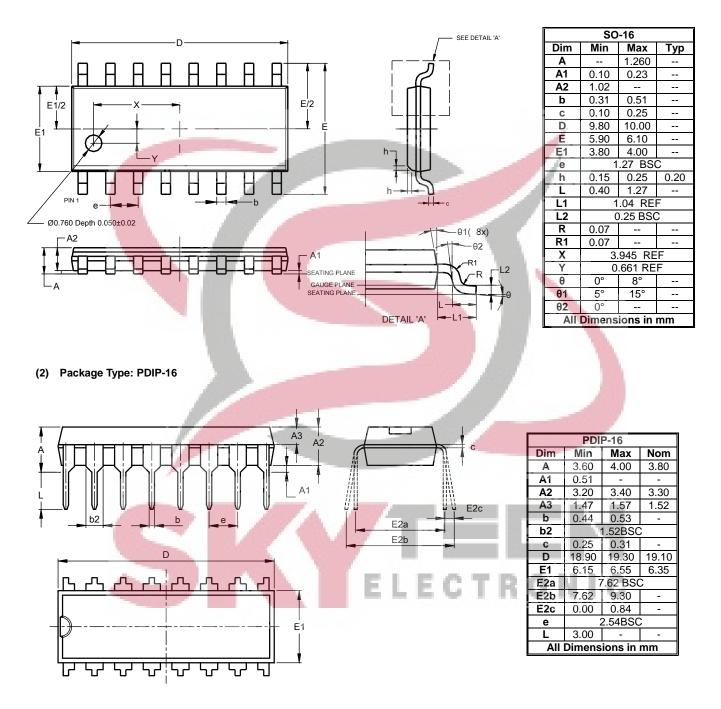
Publismeder 10 of 13 WWW.SKYTE Codes for



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SO-16

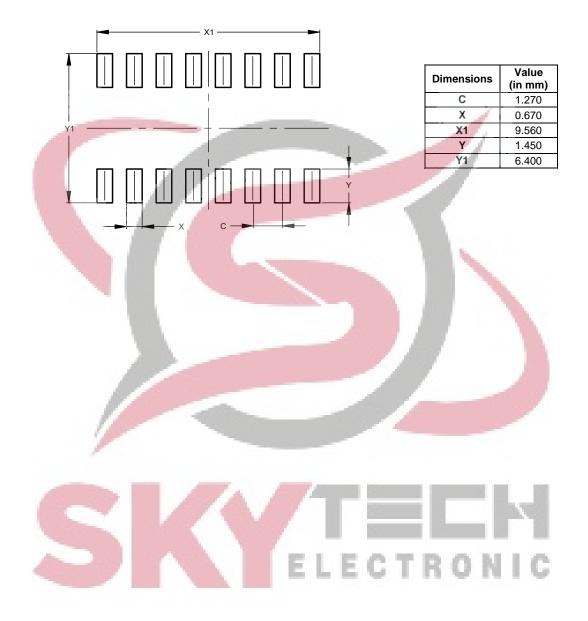




Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SO-16





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ELECTRON

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